

S-Band, GaN/SiC, 50-Ohm RF Power Transistor

2.9 - 3.4 GHz | 250 W typ | 53% Efficiency typ | 14.5dB Gain typ | 50 V | 150 µs Pulse Length, 10% Duty Cycle

IGT2934M250 is a high power GaN-on-SiC RF power transistor that is fully matched to 50Ω at both the input and output. It supplies a minimum of 250W of peak output power, with typically >14.5dB of gain and 53% efficiency. It operates from a 50V supply voltage. For optimal thermal efficiency, the transistor is housed in a metal-based package with an epoxy-sealed ceramic lid.

FEATURES

- GaN on SiC HEMT Technology
- Output Power 250W
- Fully matched to 50Ω at both input and output
- 100% RF Tested Under 150μs, 10% duty cycle pulse conditions
- RoHS and REACH Compliant

APPLICATIONS

S-band Radar Systems

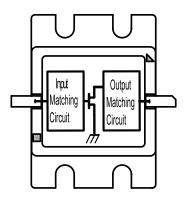


Table 1. RF Electrical Characteristics (Case temperature = 30 °C unless otherwise stated).

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions	
Gain	G	12	14.5	16	dB		
Drain Efficiency	η	47	53	60	%	P _{ουτ} = 250W f = 2.9, 3.15 3.4GHz 150μs pulse length, 10% duty cycle V _{DS} = 50V, I _{DS} = 52mA	
Pulse Droop	D	-0.8	-0.2	+0.2	dB		
Input Return Loss	IRL	5	10	25	dB		
Load Mismatch Stability	VSWR-S	2:1					
VSWR Withstand	VSWR-LMT	3:1					
Second Harmonic			-27		dBc	P _{OUT} = 250W f = 3.15 GHz 150μs pulse length, 10% duty cycle	
Third Harmonic			-58		dBc	$V_{DS} = 50V$, $I_{DS} = 52mA$	

Table 2. DC Electrical Characteristics (Case temperature = 25 °C unless otherwise stated)

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions
Gate Pinch-Off Voltage	V _P	-4.0	-3.0	-2.5	V	$V_{DS} = 50V$, $I_{DS} = 2mA$
Quiescent Gate Voltage	V _Q		-2.4		V	$V_{DS} = 50V, I_{DS} = 52mA$



Table 3. Absolute Maximum Ratings (Not Simultaneous). Case temperature = 25 °C unless otherwise stated.

Parameter	Symbol	Value	Units	Test Conditions
DC Drain-Source Voltage	V _{DS}	120	V	
DC Gate-Source Voltage	V_{gs}	-8 to +1.5	V	
DC Drain Current	I _D	24	А	
DC Gate Current	I _G	2.4	mA	
RF Input Power	P _{REIN}	12	W	
Operating Channel Temperature	Т _{сн}	-55 to +225	°C	
Storage Temperature	T _{STG}	-55 to +150	°C	
Soldering Temperature	T _{SOLDER}	260 for 10s	°C	

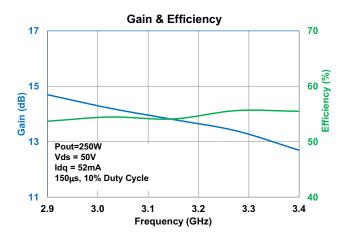
Note: Operation outside the limits given in this table may cause permanent damage to the transistor

Table 4. Thermal Resistance (Case temperature = 85 °C unless otherwise stated)

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions
Peak Thermal Resistance, Channel to Case	R _{TH}		0.36		°C/W	$P_{DISS} = 222W$ 150 μ s pulse length, 10% duty cycle $V_{DS} = 50V$



TYPICAL RF PERFORMANCE



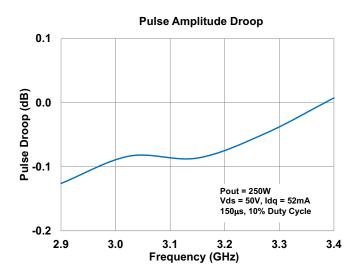


Figure 1



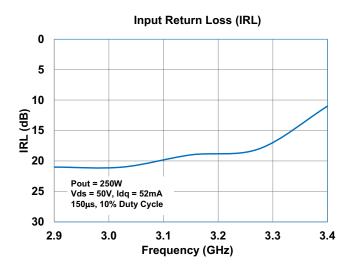
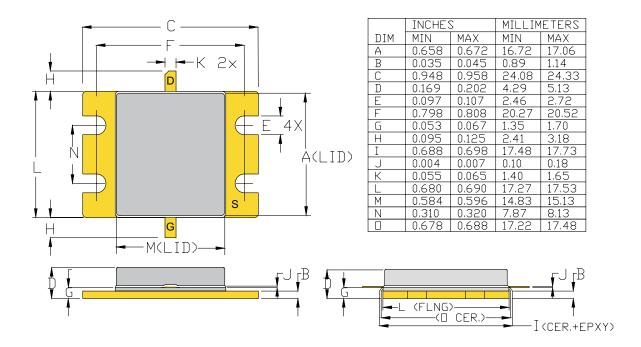


Figure 3



PACKAGE PM67A1





ESD & MSL Rating

Parameter	Rating	Standard		
ESD Human Body Model (HBM)	TBD	ESDA/JEDEC JS-001-2012		
ESD Charged Device Model (CDM)	TBD	JEDEC JESD22-C101F		
Moisture Sensitivty Level (MSL)	Unlimited Shelf Life	IPC/JEDEC J-STD-020		

RoHS Compliance

Integra Technologies, Inc declares that its GaN and LDMOS Transistor Products comply with EU Directive 2011/65/EU on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863/EU.

REACH Compliance

Integra Technologies supports EU Regulation number 1907/2006 concerning the Registration, Evaluation, Authorization, and Restriction of Chemicals (REACH) as these apply to Integra semiconductor products, development tools, and shipping packaging.

In support of the REACH regulation, Integra will:

- •Inform customers and recipients of Integra product if they contain any substances that are of very high concern (SVHC) per the European Chemical Agency (ECHA) website.
- •Notify ECHA if any Integra product that contains any SVHCs which exceed guidelines for REACH chemicals by weight per part number and for total content weight per year for all products produced in or imported to the European market.
- •Cease shipments of product containing REACH Annex XIV substances until authorization has been obtained.
- Cease shipment of product containing REACH Annex XVII chemicals when restrictions apply.

Integra has evaluated its materials, BOMs, and product specifications and product and has determined that this transistor conforms to all REACH and SVHC regulations and guidelines. Integra has implemented actions and control programs that will assure continued compliance.

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DEFINITIONS:

DATA SHEET STATUS

Advanced Specification - This data sheet contains Advanced specifications

Preliminary Specification - This data sheet contains specifications based on preliminary measurements and data.

Final Specification - This data sheet contains final product specifications.

MAXIMUM RATINGS Stress above one or more of the maximum ratings may cause permanent damage to the device. These are maximum ratings only operation of the device at these or at any other conditions above those given in the characteristics sections of the specification is not implied. Exposure to maximum values for extended periods of time may affect device reliability.

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